

DDR3-1800**Qualified Vendors List (QVL)** Standard table for user manual

Project Name:P5E3 DELUXE REV: 1.03G

Size	Vendor	Model	CL	Brand	SS/DS	Component	DIMM socket support (Optional)		
							A*	B*	C*
1GB	CORSAIR	TWIN3X2048-1800C7DF G	7	Micon	SS	Heatsink	V	V	N/A
1GB	OCZ	OCZ3P18002GK	8	Micon	SS	Heatsink	V	V	N/A
1GB	Kingston	KHX14400D3K2/2G	9	Micon	SS	Heatsink	V	V	N/A
1GB	SuperTalent	W1800UX2GP ProjectX	9	Micon	SS	Heatsink	V	V	N/A

DDR3-1600**Qualified Vendors List (QVL)** Standard table for user manual

Project Name:P5E3 DELUXE REV: 1.03G

Size	Vendor	Model	CL	Brand	SS/DS	Component	DIMM socket support (Optional)		
							A*	B*	C*
1GB	CORSAIR	CM3X1024-1600C7DHXIN	7	Micon	SS	Heatsink	V	V	N/A
1GB	OCZ	OCZ3P16002GK	7	Micon	SS	Heatsink	V	V	N/A
1GB	A-DATA	DDR3-1600X	7	Micon	SS	Heatsink	V	V	N/A
1GB	SuperTalent	W1600X2G7	7	Micon	SS	Heatsink	V	V	N/A
1GB	SuperTalent	W1600UX2GP ProjectX	7	Micon	SS	Heatsink	V	V	N/A
1GB	Kingston	KHX13000D3LLK2/2G	7	Micon	SS	Heatsink	V	V	N/A
1GB	OCZ	Titanium Edition OCZ3T1600XM2GK	7	Micon	SS	Heatsink	V	V	N/A

DDR3-1333**Qualified Vendors List (QVL)** Standard table for user manual

Project Name:

Size	Vendor	Chip No.	CL	Chip Brand	SS/DS	Part No.	DIMM socket support (Optional)		
							A*	B*	C*
DDR3 1333 512MB	ELPIDA	J5308BASE-DG-E	8	ELPIDA	SS	EBJ51UD8 BAFA-DG-	v	v	v
DDR3 1333 1024MB	SAMSUNG	K4B1G0846C-ZCF8	8	SAMSUNG	SS	M378B2873 CZ0-CG9	v	v	
DDR3 1333 1024MB	OCZ	Heat-Sink Package	7-7-7-20	N/A	DS	OCZ3P1333 2GK	v	v	v

DDR3-1066**Qualified Vendors List (QVL)** Standard table for user manual

Project Name:

Size	Vendor	Chip No.	CL	Chip Brand	SS/DS	Part No.	DIMM socket support (Optional)		
							A*	B*	C*
DDR3 1067 512MB	Qimonda	IDSH51-03A1F1C-10F	N/A	QIMONDA	SS	IMSH51U03 A1F1C-10F	v	v	v
DDR3 1067 1024MB	Qimonda	IDSH51-03A1F1C-10F	N/A	QIMONDA	DS	IMSH1GU1 3A1F1C-	v	v	
DDR3 1067 512MB	ELPIDA	J5308BASE-AC-E	8	ELPIDA	SS	EBJ51UD8 BAFA-AG-	v	v	v
DDR3 1067 1024MB	ELPIDA	J5308BASE-AC-E	8	ELPIDA	DS	EBJ11UD8 BAFA-AG-	v	v	
DDR3 1067 512MB	NANYA	NT5CB64M8AN-BE	N/A	NANYA	SS	NT512C64B 88A0NY-BF	v	v	v
DDR3 1067 1024MB	MICRON	D9GTR	7	MICRON	SS	MT8JTF128 64AY- 1G1BZES	v	v	
DDR3 1067 2048MB	MICRON	Z9HWQ	7	MICRON	DS	MT16JTF25 664AY- 1G1BYES	v		
DDR3 1067 1024MB	SAMSUNG	K4B1G0846C-ZCF8	7-7-7	SAMSUNG	SS	M378B2873 CZ0-CF8	v	v	
DDR3 1067 1024MB	SAMSUNG	K4B1G0846C-ZCG8	8	SAMSUNG	SS	M378B2873 CZ0-CG8	v	v	
DDR3 1067 2048MB	SAMSUNG	K4B1G0846C-ZCF8	7	SAMSUNG	DS	M378B5673 CZ0-CF8	v		
DDR3 1067 1024MB	SAMSUNG	K4B1G0846C-ZCF8	7	SAMSUNG	SS	M391B2873 CZ0-CF8	v	v	
DDR3 1067 512MB	Kingston	IDSH51-03A1F1C-10F	N/A	QIMONDA	SS	KVR1066D3 N7/512	v	v	v
DDR3 1067 1024MB	Kingston	J5308BASE-AC-E	7	ELPIDA	DS	KVR1066D3 N7/1G	v	v	
DDR3 1067 512MB	Kingston	J5308BASE-AC-E	7	ELPIDA	SS	KVR1066D3 N7/512	v	v	v

DDR3 1067 1024MB	CORSAIR	Heat-Sink Package	7	N/A	DS	CM3X1024- 1066C7	v	v	
DDR3 1067 1024MB	Hynix	HY5TQ1G831ZNFP-G7	7	HYNIX	SS	HYMT112U 64ZNF8-G7	v	v	
DDR3 1067 2048MB	Hynix	HY5TQ1G831ZNFP-G7	7	HYNIX	DS	HYMT125U 64ZNF8-G7	v		
DDR3 1067 512MB	GEIL	Heat-Sink Package	6	N/A	SS	G31GB1066 C6DC	v	v	v
DDR3 1067 1024MB	WINTEC	IDSH51-03A1F1C-10F	7	QIMONDA	DS	3DU3191A- 10	v	v	v

DDR3-800

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Project Name:

Size	Vendor	Chip No.	CL	Chip Brand	SS/DS	Part No.	DIMM socket support (Optional)		
							A*	B*	C*
DDR3 800 512MB	ELPIDA	J5308BASE-AC-E	6	ELPIDA	SS	EBJ51UD8 BAFA-8C-E	v	v	v
DDR3 800 1024MB	ELPIDA	J5308BASE-AC-E	6	ELPIDA	DS	EBJ11UD8 BAFA-8C-E	v	v	v
DDR3 800 512MB	NANYA	NT5CB64M8AN-25D	N/A	NANYA	SS	NT512C64B 88A0NY-	v	v	v
DDR3 800 1024MB	NANYA	NT5CB64M8AN-25D	N/A	NANYA	DS	NT1GC64B 8HA0NY-	v	v	v
DDR3 800 1024MB	Qimonda	IDSH51-03A1F1C-08E	N/A	QIMONDA	DS	IMSH1GU1 3A1F1C-	v	v	v
DDR3 800 512MB	Qimonda	IDSH51-03A1F1C-08D	N/A	Qimonda	SS	IMSH51U03 A1F1C-08D	v	v	v
DDR3 800 512MB	Qimonda	IDSH51-03A1F1C-08E	N/A	Qimonda	SS	IMSH51U03 A1F1C-08E	v	v	v
DDR3 800 1024MB	Hynix	HY5TQ1G831ZNF-S6	N/A	Hynix	SS	HYMT112U 64ZNF8-S6	v	v	v
DDR3 800 2048MB	Hynix	HY5TQ1G831ZNF-S5	N/A	Hynix	DS	HYMT125U 64ZNF8-S5	v	v	v

Note :

A* : Supports one module inserted in any slot as Single-channel memory configuration

B* : Supports one pair of modules inserted into either the orange slots or the black slots as one pair of Dual-channel memory configuration

C* : Supports 4 modules inserted into both the orange and black slots as two pairs of Dual-channel memory configuration